V53C8125L ULTRA-HIGH PERFORMANCE, 3.3 VOLT 128K x 8 BIT FAST PAGE MODE CMOS DYNAMIC RAM

PRELIMINARY

HIGH PERFORMANCE	60
Max. RAS Access Time, (t _{RAC})	60 ns
Max. Column Address Access Time, (t _{CAA})	30 ns
Min. Fast Page Mode Cycle Time, (t _{PC})	40 ns
Min. Read/Write Cycle Time, (t _{RC})	120 ns

Features

- 128K x 8-bit organization
- Fast Page Mode supports sustained data rates of 25 MHz
- RAS access time: 60 ns
- Read-Modify-Write, RAS-Only Refresh, CAS-Before-RAS Refresh capability
- Refresh Interval: 256 cycles/8 ms
- Available in 26/24 pin 300 mil SOJ and 28-pin TSOP-I packages
- Single +3.3 V \pm 0.3 V power supply
- TTL Interface

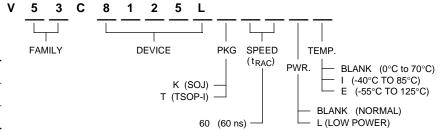
Description

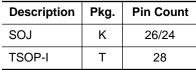
The V53C8125L is a high speed 131,072 x 8 bit CMOS dynamic random access memory. The V53C8125L offers a combination of features: Fast Page Mode for high data bandwidth, fast usable speed, CMOS standby current.

All inputs and outputs are TTL compatible. Input and output capacitances are significantly lowered to allow increased system performance. Fast Page Mode operation allows random access of up to 512 columns (x9) bits within a row with cycle times as short as 40 ns. Because of static circuitry, the $\overline{\text{CAS}}$ clock is not in the critical timing path. The flow-through column address latches allow address pipelining while relaxing many critical system timing requirements for fast usable speed. These features make the V53C8125L ideally suited for graphics, digital signal processing and high performance peripherals.

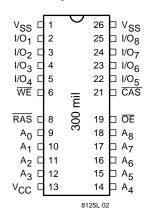
Device Usage Chart

Operating	Package Outline		Access Time (ns)	Power	Townsetows
Temperature Range	K	Т	60 Std.		Temperature Mark
0°C to 70°C	•	•	•	•	Blank
-40°C to 85°C	•	•	•	•	I
-55°C to 125°C	•	•	•	•	Е



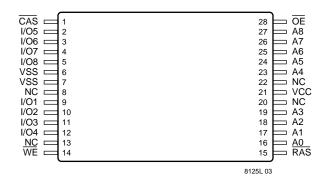


26/24 Lead SOJ PIN CONFIGURATION Top View



28 Lead TSOP-I PIN CONFIGURATION Top View

8125L 01



Pin Names

A ₀ -A ₈	Address Inputs (A ₈ : Column Address only)
RAS	Row Address Strobe
CAS	Column Address Strobe
WE	Write Enable
ŌĒ	Output Enable
I/O ₁ -I/O ₈	Data Input, Output
V _{CC}	+3.3V Supply
V _{SS}	0V Supply
NC	No Connect

Absolute Maximum Ratings*

*Note: Operation above Absolute Maximum Ratings can adversely affect device reliability.

Power Dissipation......1.0 W

Capacitance*

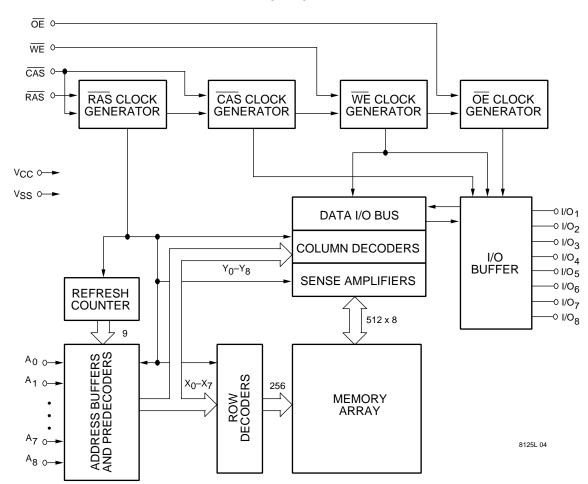
 $T_A = 25^{\circ}C$, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, f = 1 MHz

Symbol	Parameter	Тур.	Max.	Unit
C _{IN1}	Address Input	3	4	pF
C _{IN2}	RAS, CAS, WE, OE	4	5	pF
C _{OUT}	Data Input/Output	5	7	pF

^{*}Note: Capacitance is sampled and not tese

Block Diagram

128K x 8



V53C8125L **MOSEL VITELIC**

DC and Operating Characteristics (1-2) T_A = 0°C to 70°C, V_{CC} = 3.3 V \pm 0.3 V, V_{SS} = 0 V, unless otherwise specified.

		Access	V53C8125L						
Symbol	Parameter	Time	Min.	Тур.	Max.	Unit	Test Conditions	Notes	
ILI	Input Leakage Current (any input pin)		-10		10	μА	$V_{SS} \le V_{IN} \le V_{CC}$		
I _{LO}	Output Leakage Current (for High-Z State)		-10		10	μА	$\frac{V_{SS} \le V_{OUT} \le V_{CC}}{RAS, \overline{CAS}}$ at V_{IH}		
I _{CC1}	V _{CC} Supply Current, Operating	60			120	mA	$t_{RC} = t_{RC} \text{ (min.)}$	1, 2	
I _{CC2}	V _{CC} Supply Current, TTL Standby				2	mA	\overline{RAS} , \overline{CAS} at V_{IH} other inputs $\geq V_{SS}$		
I _{CC3}	V _{CC} Supply Current, RAS-Only Refresh	60			120	mA	$t_{RC} = t_{RC} \text{ (min.)}$	2	
I _{CC4}	V _{CC} Supply Current, Fast Page Mode Operation	60			110	mA	Minimum Cycle	1, 2	
I _{CC5}	V _{CC} Supply Current, Standby, Output Enabled				2.0	mA	$\overline{RAS} = V_{IH}, \ \overline{CAS} = V_{IL}$ other inputs $\geq V_{SS}$	1	
I _{CC6}	V _{CC} Supply Current, CMOS Standby				2.0	mA	$\overline{RAS} \ge V_{CC} - 0.2 \text{ V},$ $\overline{CAS} \ge V_{CC} - 0.2 \text{ V},$ All other inputs $\ge V_{SS}$		
V _{IL}	Input Low Voltage		-1		0.8	V		3	
V _{IH}	Input High Voltage		2.0		V _{CC} +1	V	_	3	
V _{OL}	Output Low Voltage				0.4	V	I _{OL} = 2.0 mA		
V _{OH}	Output High Voltage		2.4			V	I _{OH} = -2.0 mA		

V53C8125L **MOSEL VITELIC**

 $\pmb{AC\ Characteristics}$ $T_A=0^{\circ}C$ to 70°C, $V_{CC}=3.3\ V\pm0.3\ V,\ V_{SS}=0V$ unless otherwise noted AC Test conditions, input pulse levels 0 to 3V

	JEDEC			60			
#	Symbol	Symbol	Parameter	Min.	Max.	Unit	Notes
1	t _{RL1RH1}	t _{RAS}	RAS Pulse Width	60	75K	ns	
2	t _{RL2RL2}	t _{RC}	Read or Write Cycle Time	120		ns	
3	t _{RH2RL2}	t _{RP}	RAS Precharge Time	50		ns	
4	t _{RL1CH1}	t _{CSH}	CAS Hold Time	60		ns	
5	t _{CL1CH1}	t _{CAS}	CAS Pulse Width	15		ns	
6	t _{RL1CL1}	t _{RCD}	RAS to CAS Delay	20	45	ns	
7	t _{WH2CL2}	t _{RCS}	Read Command Setup Time	0		ns	4
8	t _{AVRL2}	t _{ASR}	Row Address Setup Time	0		ns	
9	t _{RL1AX}	t _{RAH}	Row Address Hold Time	10		ns	
10	t _{AVCL2}	t _{ASC}	Column Address Setup Time	0		ns	
11	t _{CL1AX}	t _{CAH}	Column Address Hold Time	10		ns	
12	t _{CL1RH1(R)}	t _{RSH (R)}	RAS Hold Time (Read Cycle)	15		ns	
13	t _{CH2RL2}	t _{CRP}	CAS to RAS Precharge Time	5		ns	
14	t _{CH2WX}	t _{RCH}	Read Command Hold Time Referenced to CAS	0		ns	5
15	t _{RH2WX}	t _{RRH}	Read Command Hold Time Referenced to RAS	0		ns	5
16	t _{OEL1RH2}	t _{ROH}	RAS Hold Time Referenced to OE	10		ns	
17	t _{GL1QV}	t _{OAC}	Access Time from $\overline{\text{OE}}$		15	ns	
18	t _{CL1QV}	t _{CAC}	Access Time from CAS		15	ns	6, 7
19	t _{RL1QV}	t _{RAC}	Access Time from RAS		60	ns	6, 8, 9
20	t _{AVQV}	t _{CAA}	Access Time from Column Address		30	ns	6, 7, 10
21	t _{CL1QX}	t _{LZ}	OE or CAS to Low-Z Output	0		ns	16
22	t _{CH2QZ}	t _{HZ}	OE or CAS to High-Z Output	0	10	ns	16
23	t _{RL1AX}	t _{AR}	Column Address Hold Time from RAS	50		ns	
24	t _{RL1AV}	t _{RAD}	RAS to Column Address Delay Time	15	30	ns	11
25	t _{CL1RH1(W)}	t _{RSH (W)}	RAS or CAS Hold Time in Write Cycle	15		ns	
26	t _{WL1CH1}	t _{CWL}	Write Command to CAS Lead Time	15		ns	
27	t _{WL1CL2}	t _{WCS}	Write Command Setup Time	0		ns	12, 13
28	t _{CL1WH1}	t _{WCH}	Write Command Hold Time	10		ns	
29	t _{WL1WH1}	t _{WP}	Write Pulse Width	10		ns	
30	t _{RL1WH1}	t _{WCR}	Write Command Hold Time from RAS	50		ns	
31	t _{WL1RH1}	t _{RWL}	Write Command to RAS Lead Time	15		ns	
32	t _{DVWL2}	t _{DS}	Data in Setup Time	0		ns	14
33	t _{WL1DX}	t _{DH}	Data in Hold Time	10		ns	14

AC Characteristics (Cont'd)

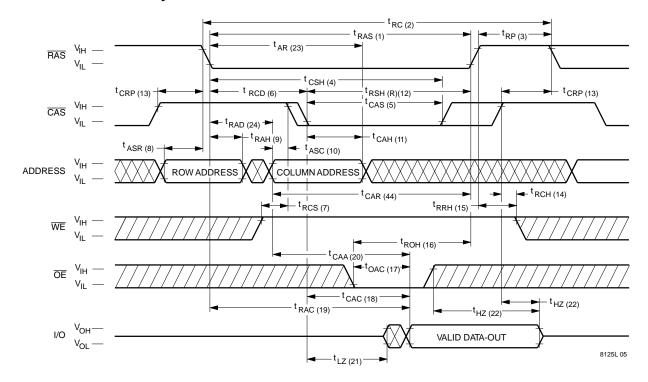
	JEDEC	IEDEC		60			
#	Symbol	Symbol	Parameter	Min.	Max.	Unit	Notes
34	t _{WL1GL2}	t _{WOH}	Write to OE Hold Time	10		ns	14
35	t _{GH2DX}	t _{OED}	OE to Data Delay Time	10		ns	14
36	t _{RL2RL2} (RMW)	t _{RWC}	Read-Modify-Write Cycle Time	170		ns	
37	t _{RL1RH1} (RMW)	t _{RRW}	Read-Modify-Write Cycle RAS Pulse Width	105		ns	
38	t _{CL1WL2}	t _{CWD}	CAS to WE Delay	40		ns	12
39	t _{RL1WL2}	t _{RWD}	RAS to WE Delay in Read-Modify-Write Cycle	85		ns	12
40	t _{CL1CH1}	t _{CRW}	CAS Pulse Width (RMW)	65		ns	
41	t _{AVWL2}	t _{AWD}	Col. Address to WE Delay	58		ns	12
42	t _{CL2CL2}	t _{PC}	Fast Page Mode Read or Write Cycle Time	40		ns	
43	t _{CH2CL2}	t _{CP}	CAS Precharge Time	10		ns	
44	t _{AVRH1}	t _{CAR}	Column Address to RAS Setup Time	30		ns	
45	t _{CH2QV}	t _{CAP}	Access Time from Column Precharge		34	ns	7
46	t _{RL1DX}	t _{DHR}	Data in Hold Time Referenced to RAS	50		ns	
47	t _{CL1RL2}	t _{CSR}	CAS Setup Time CAS-before-RAS Refresh	10		ns	
48	t _{RH2CL2}	t _{RPC}	RAS to CAS Precharge Time	0		ns	
49	t _{RL1CH1}	t _{CHR}	CAS Hold Time CAS-before-RAS Refresh	15		ns	
50	t _{CL2CL2} (RMW)	t _{PCM}	Fast Page Mode Read-Modify-Write Cycle Time	85		ns	
51	t _T	t _T	Transition Time (Rise and Fall)	5	50	ns	15
52		t _{REF}	Refresh Interval (512 Cycles)		8	ms	17

Notes:

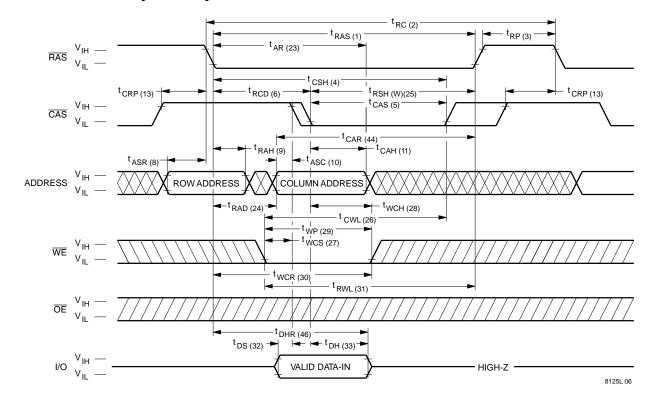
 I_{CC} is dependent on output loading when the device output is selected. Specified I_{CC} (max.) is measured with the output open.

- 2. I_{CC} is dependent upon the number of address transitions. Specified I_{CC} (max.) is measured with a maximum of two transitions per address cycle in Fast Page Mode.
- 3. Specified V_{IL} (min.) is steady state operating. During transitions, V_{IL} (min.) may undershoot to -1.0 V for a period not to exceed 20 ns. All AC parameters are measured with V_{IL} (min.) $\geq V_{SS}$ and V_{IH} (max.) $\leq V_{CC}$.
- t_{RCD} (max.) is specified for reference only. Operation within t_{RCD} (max.) limits insures that t_{RAC} (max.) and t_{CAA} (max.) can be met. If t_{RCD} is greater than the specified t_{RCD} (max.), the access time is controlled by t_{CAA} and t_{CAC}.
- 5. Either t_{RRH} or t_{RCH} must be satisified for a Read Cycle to occur.
- 6. Measured with a load equivalent to one TTL inputs and 50 pF.
- 7. Access time is determined by the longest of t_{CAA} , t_{CAC} and t_{CAP} .
- Assumes that t_{RAD} ≤ t_{RAD} (max.). If t_{RAD} is greater than t_{RAD} (max.), t_{RAC} will increase by the amount that t_{RAD} exceeds t_{RAD} (max.).
- 9. Assumes that $t_{RCD} \le t_{RCD}$ (max.). If t_{RCD} is greater than t_{RCD} (max.), t_{RAC} will increase by the amount that t_{RCD} exceeds t_{RCD} (max.).
- 10. Assumes that $t_{RAD} \ge t_{RAD}$ (max.).
- 11. Operation within the t_{RAD} (max.) limit ensures that t_{RAC} (max.) can be met. t_{RAD} (max.) is specified as a reference point only. If t_{RAD} is greater than the specified t_{RAD} (max.) limit, the access time is controlled by t_{CAA} and t_{CAC}.
- 12. t_{WCS} , t_{RWD} , t_{AWD} and t_{CWD} are not restrictive operating parameters.
- 13. t_{WCS} (min.) must be satisfied in an Early Write Cycle.
- 14. t_{DS} and t_{DH} are referenced to the latter occurrence of \overline{CAS} or \overline{WE} .
- 15. t_T is measured between V_{IH} (min.) and V_{IL} (max.). AC-measurements assume $t_T = 5$ ns.
- 16. Assumes a three-state test load (5 pF and a 380 Ohm Thevenin equivalent).
- 17. An initial 200 μs pause and 8 RAS-containing cycles are required when exiting an extended period of bias without clocks. An extended period of time without clocks is defined as one that exceeds the specified Refresh Interval.

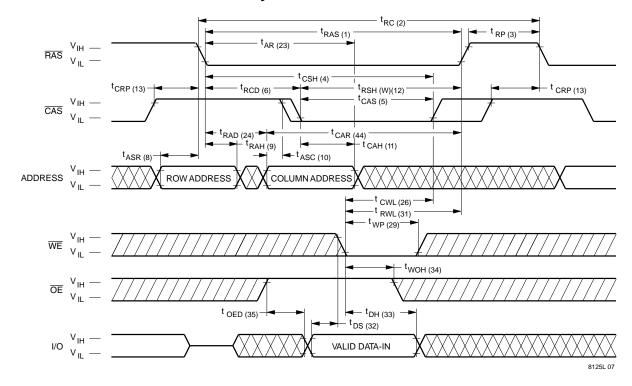
Waveforms of Read Cycle



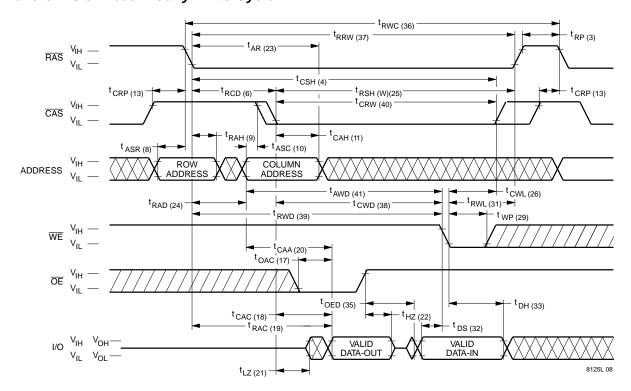
Waveforms of Early Write Cycle



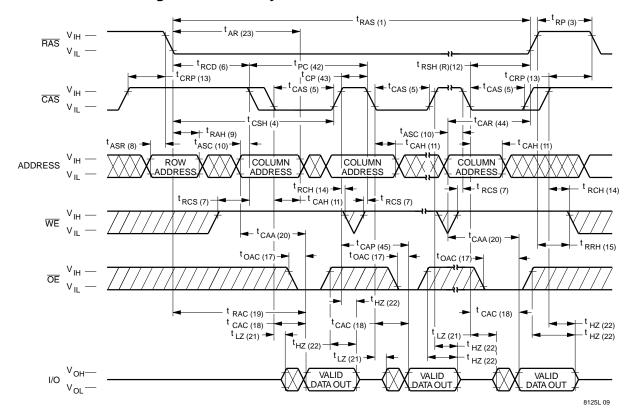
Waveforms of OE-Controlled Write Cycle



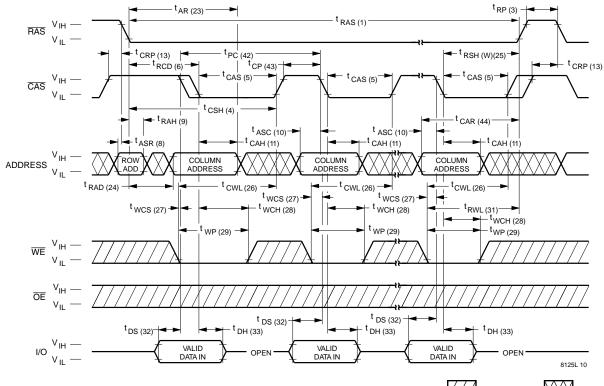
Waveforms of Read-Modify-Write Cycle



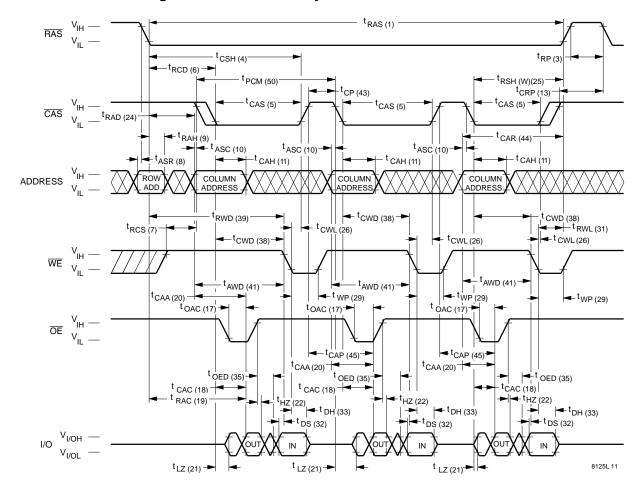
Waveforms of Fast Page Mode Read Cycle



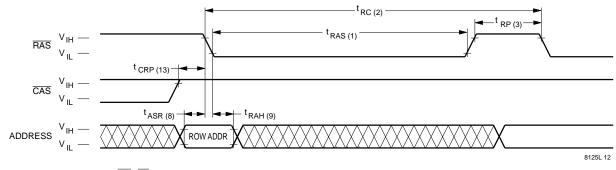
Waveforms of Fast Page Mode Write Cycle



Waveforms of Fast Page Mode Read-Write Cycle

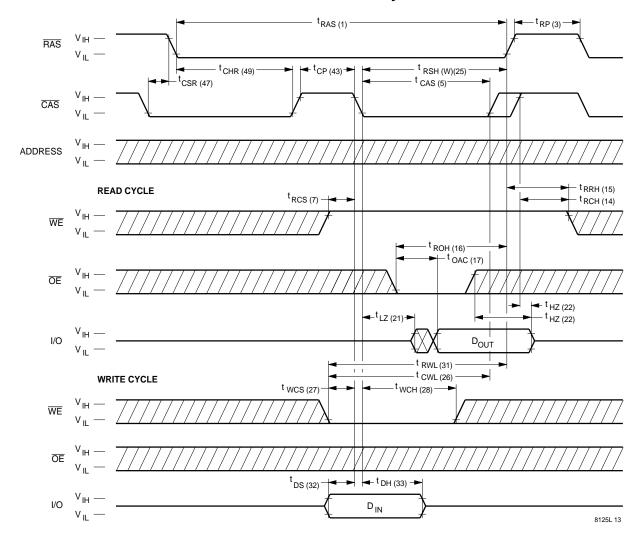


Waveforms of RAS-Only Refresh Cycle

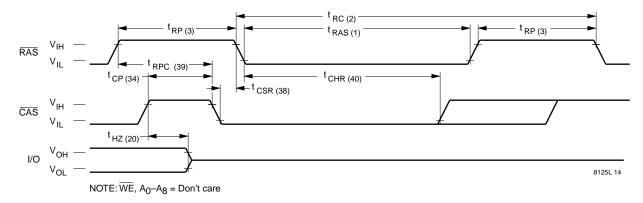


NOTE: \overline{WE} , \overline{OE} = Don't care

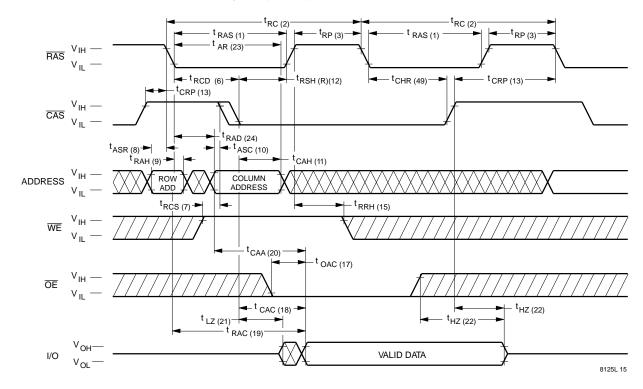
Waveforms of CAS-before-RAS Refresh Counter Test Cycle



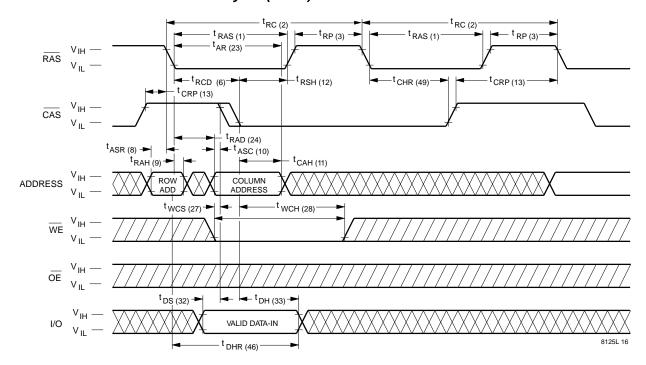
Waveforms of CAS-before-RAS Refresh Cycle



Waveforms of Hidden Refresh Cycle (Read)



Waveforms of Hidden Refresh Cycle (Write)



Functional Description

The V53C8125L is a CMOS dynamic RAM optimized for high data bandwidth, low power applications. It is functionally similar to a traditional dynamic RAM. The V53C8125L reads and writes data by multiplexing an 17-bit address into a 9-bit row and an 8-bit column address. The row address is latched by the Row Address Strobe (RAS). The column address "flows through" an internal address buffer and is latched by the Column Address Strobe (CAS). Because access time is primarily dependent on a valid column address rather than the precise time that the CAS edge occurs, the delay time from RAS to CAS has little effect on the access time.

Memory Cycle

A memory cycle is initiated by bringing \overline{RAS} low. Any memory cycle, once initiated, must not be ended or aborted before the minimum t_{RAS} time has expired. This ensures proper device operation and data integrity. A new cycle must not be initiated until the minimum precharge time t_{RP}/t_{CP} has elapsed.

Read Cycle

A Read cycle is performed by holding the Write Enable (\overline{WE}) signal High during a $\overline{RAS}/\overline{CAS}$ operation. The column address must be held for a minimum specified by t_{AR} . Data Out becomes valid only when t_{OAC} , t_{RAC} , t_{CAA} and t_{CAC} are all satisifed. As a result, the access time is dependent on the timing relationships between these parameters. For example, the access time is limited by t_{CAA} when t_{RAC} , t_{CAC} and t_{OAC} are all satisfied.

Write Cycle

A Write Cycle is performed by taking $\overline{\text{WE}}$ and $\overline{\text{CAS}}$ low during a $\overline{\text{RAS}}$ operation. The column address is latched by $\overline{\text{CAS}}$. The Write Cycle can be $\overline{\text{WE}}$ controlled or $\overline{\text{CAS}}$ controlled depending on whether $\overline{\text{WE}}$ or $\overline{\text{CAS}}$ falls later. Consequently, the input data must be valid at or before the falling edge of $\overline{\text{WE}}$ or $\overline{\text{CAS}}$, whichever occurs last. In the $\overline{\text{CAS}}$ -controlled Write Cycle, when the leading edge of $\overline{\text{WE}}$ occurs prior to the $\overline{\text{CAS}}$ low transition, the I/O data pins will be in the High-Z state at the beginning of the Write function. Ending the Write with $\overline{\text{RAS}}$ or $\overline{\text{CAS}}$ will maintain the output in the High-Z state.

In the $\overline{\text{WE}}$ controlled Write Cycle, $\overline{\text{OE}}$ must be in the high state and t_{OED} must be satisfied.

Refresh Cycle

To retain data, 256 Refresh Cycles are required in each 8 ms period. There are two ways to refresh the memory:

- By clocking each of the 512 row addresses (A₀ through A₈) with RAS at least once every 8 ms.
 Any Read, Write, Read-Modify-Write or RAS-only cycle refreshes the addressed row.
- Using a CAS-before-RAS Refresh Cycle. If CAS makes a transition from low to high to low after the previous cycle and before RAS falls, CAS-before-RAS refresh is activated. The V53C8125H uses the output of an internal 9-bit counter as the source of row addresses and ignore external address inputs.

CAS-before-RAS is a "refresh-only" mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle. A CAS-before-RAS counter test mode is provided to ensure reliable operation of the internal refresh counter.

Fast Page Mode Operation

Fast Page Mode operation permits all 256 columns within a selected row of the device to be randomly accessed at a high data rate. Maintaining RAS low while performing successive CAS cycles retains the row address internally and eliminates the need to reapply it for each cycle. The column address buffer acts as a transparent or flow-through latch while CAS is high. Thus, access begins from the occurrence of a valid column address rather than from the falling edge of CAS, eliminating t_{ASC} and t_T from the critical timing path. CAS latches the address into the column address buffer and acts as an output enable. During Fast Page Mode operation, Read, Write, Read-Modify-Write or Read-Write-Read cycles are possible at random addresses within a row. Following the initial entry cycle into Fast Page Mode, access is t_{CAA} or t_{CAP} controlled. If the column address is valid prior to the rising edge of \overline{CAS} , the access time is referenced to the \overline{CAS} rising edge and is specified by t_{CAP} . If the column address is valid after the rising CAS edge, access is timed from the occurrence of a valid address and is specified by t_{CAA}. In both cases, the falling edge of CAS latches the address and enables the output.

Fast Page Mode provides sustained data rates of 25 MHz for applications that require high data rates such as bit-mapped graphics or high-speed signal processing. The following equation can be used to calculate the maximum data rate:

$$\text{Data Rate } = \frac{256}{t_{\text{RC}} + 255 \times t_{\text{PC}}}$$

Data Output Operation

The V53C8125L Input/Output is controlled by $\overline{\text{OE}}$, $\overline{\text{CAS}}$, $\overline{\text{WE}}$ and $\overline{\text{RAS}}$. A $\overline{\text{RAS}}$ low transition enables the transfer of data to and from the selected row address in the Memory Array. A $\overline{\text{RAS}}$ high transition disables data transfer and latches the output data if the output is enabled. After a memory cycle is initiated with a $\overline{\text{RAS}}$ low transition, a $\overline{\text{CAS}}$ low transition or $\overline{\text{CAS}}$ low level enables the internal I/O path. A $\overline{\text{CAS}}$ high transition or a $\overline{\text{CAS}}$ high level disables the I/O path and the output driver if it is enabled. A $\overline{\text{CAS}}$ low transition while $\overline{\text{RAS}}$ is high has no effect on the I/O data path or on the output drivers. The output drivers, when otherwise enabled,

can be disabled by holding \overline{OE} high. The \overline{OE} signal has no effect on any data stored in the output latches. A \overline{WE} low level can also disable the output drivers when \overline{CAS} is low. During a Write cycle, if \overline{WE} goes low at a time in relationship to \overline{CAS} that would normally cause the outputs to be active, it is necessary to use \overline{OE} to disable the output drivers prior to the \overline{WE} low transition to allow Data In Setup Time (t_{DS}) to be satisfied.

Power-On

After application of the V_{CC} supply, an initial pause of 200 μs is required followed by a minimum of 8 initialization cycles (any combination of cycles containing a \overline{RAS} clock). Eight initialization cycles are required after extended periods of bias without clocks (greater than the Refresh Interval).

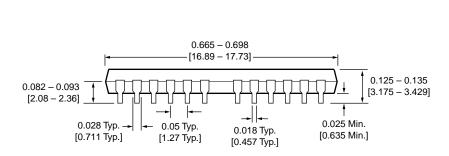
During Power-On, the V_{CC} current requirement of the V53C8125L is dependent on the input levels of \overline{RAS} and \overline{CAS} . If \overline{RAS} is low during Power-On, the device will go into an active cycle and I_{CC} will exhibit current transients. It is recommended that \overline{RAS} and \overline{CAS} track with V_{CC} or be held at a valid V_{IH} during Power-On to avoid current surges.

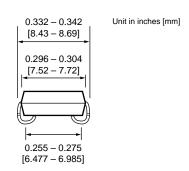
Table 1. V53C8125L Data OutputOperation for Various Cycle Types

Cycle Type	I/O State
Read Cycles	Data from Addressed Memory Cell
CAS-Controlled Write Cycle (Early Write)	High-Z
WE-Controlled Write Cycle (Late Write)	OE Controlled. High OE = High-Z I/Os
Read-Modify-Write Cycles	Data from Addressed Memory Cell
Fast Page Mode Read	Data from Addressed Memory Cell
Fast Page Mode Write Cycle (Early Write)	High-Z
Fast Page Mode Read- Modify-Write Cycle	Data from Addressed Memory Cell
RAS-only Refresh	High-Z
CAS-before-RAS Refresh Cycle	Data remains as in previous cycle
CAS-only Cycles	High-Z

Package Outlines

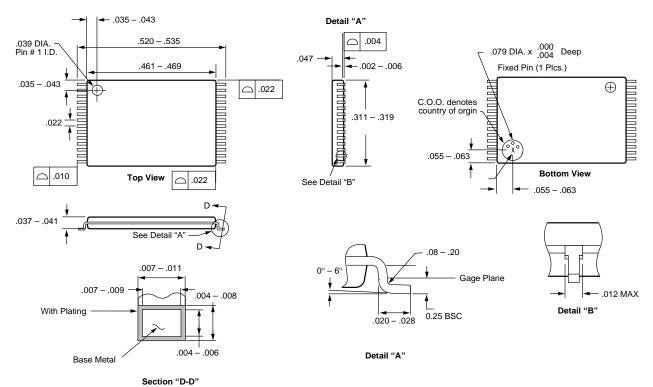
26/24-pin 300 mil SOJ





28 pin TSOP-I

Unit in inches



MOSEL VITELIC

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V53C8125L

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